

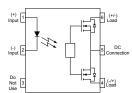
Parameter	Symbol	Rating	Units	
Load Voltage	VL	60	V	
Load Current	lι	0.2	Α	
On-Resistance	Ron	2.0	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	



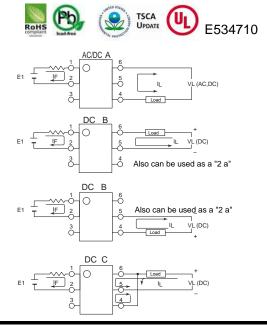
SMD-6



DIP-6



- 1. LED Anode
- 2. LED Cathode
- 4. Drain (MOS FET)
- 5. Source (MOS FET)
- 6. Drain (MOS FET)



APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Applications

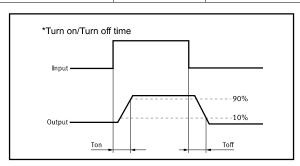
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category Coutput Rating Load Voltage Load Curre		out Rating	Package	Part No.	Packing Quantity	
		Load Current	Fackage	Fait No.		
AC/DC 60V 0.2A		DIP-6	APV212E	50pcs /tube		
AC/DC 60V	U.ZA	SMD-6	APV212EH	1000pcs /reel		





Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Va l ue	Units	Note
	Continuous LED Current	I F	50	mA	
Input	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%
·	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	l.	0.2	Α	
	Peak Load Current	Peak	0.5	А	100ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Powe	er Dissipation	Рт	500	mW	
I/O Breakd	own Voltage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating	Temperature	Topr	-40 to 85	°C	
Storage Te	emperature	T _{stg}	-40 to 100	°C	
Pin Solder	ing Temperature	T _{sol}	260	°C	10 sec max.

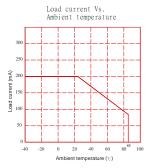
Electrical Characteristics (Ta = 25°C)

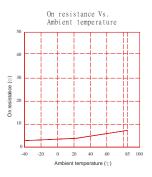
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	V	I ⊧=10mA
	Operation LED Current	Fon		0.5	2.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	VFoff	0.7			V	
	On-Resistance	Ron		2.0	8.0	Ω	I⊧=5mA,I∟=100mA, Time to flow is within 1 sec.
Output	Off-State Leakage Current	Leak	0.01	0.03	0.10	uA	V _L =Rating
	Output Capacitance	Cout		12		pF	VL=0, f=1MHz
Transmis	Turn-On Time	Ton		0.05	0.80	ms	I⊧=5mA, I∟=100mA,
sion	Turn-Off Time	Toff		0.05	0.15	ms	
	I/O Isolation Resistance	Rı⁄o	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

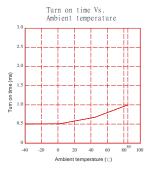
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

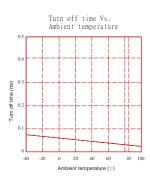


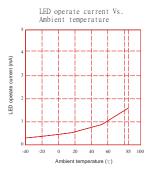
Engineering Data

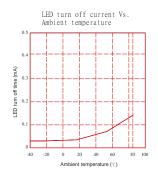


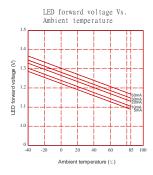


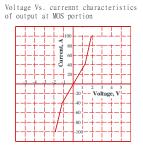


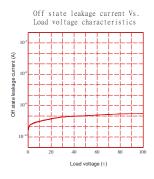


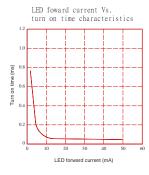


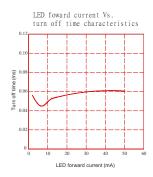


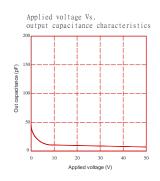










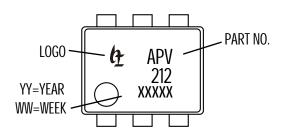


Rev 1

Dimensions and DIP-6 Package

Unit: mm

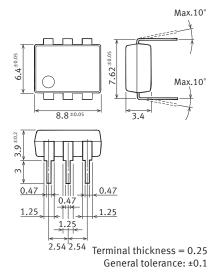
Marking



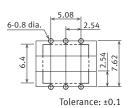
Lable



Through hole terminal type



PC board pattern (Bottom view)



DIP Tape dimensions Unit:mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.





LOG0

YY=YEAR WW=WEEK

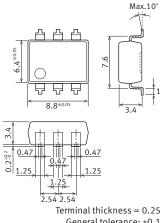
Dimensions and SMD-6 Package Unit: mm

Marking PART NO.

Lable



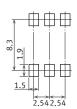
Surface mount terminal type



General tolerance: ±0.1

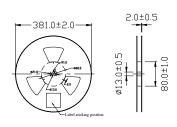
Recommended mounting pad

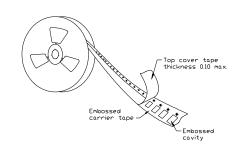
(Top view)

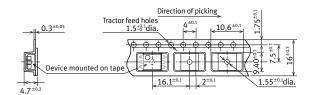


Tolerance: ±0.1

Tape dimensions (tape reel)



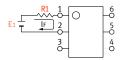


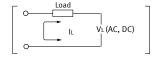




Using Methods

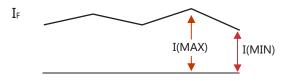
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



Recommended Operating Conditions

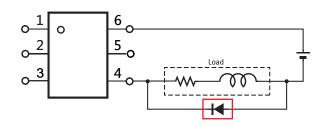
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

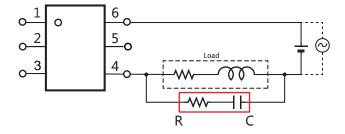
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



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